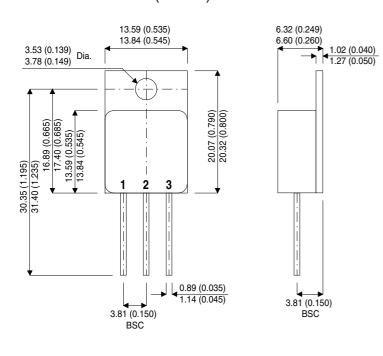




MECHANICAL DATA

Dimensions in mm (inches)



TO-254AA - Isolated Metal Package

Pin 1 – Drain

Pin 2 - Source

Pin 3 - Gate

N-CHANNEL POWER MOSFET

 V_{DSS} **200V** I_{D(cont)} 27.4A

R_{DS(on)} 0.100Ω

FEATURES

- N-CHANNEL MOSFET
- HIGH VOLTAGE
- INTEGRAL PROTECTION DIODE
- HERMETIC ISOLATED TO-254 PACKAGE
- SIDE TAB & TABLESS PACKAGE **OPTIONS AVAILABLE**
- SCREENING OPTIONS AVAILABLE

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C unless otherwise stated)

$\overline{V_{GS}}$	Gate – Source Voltage	±20V		
I_{D}	Continuous Drain Current @ $V_{GS} = 10V$, $T_C =$		27.4A	
		@ $V_{GS} = 10V$, $T_{C} = 100^{\circ}C$	17A	
I_{DM}	Pulsed Drain Current		110A	
P_{D}	Max. Power Dissipation	@ T _C = 25°C	150W	
	Linear Derating Factor		1.2W / °C	
IL	Avalanche Current , Clamped 1	27.4A		
dv / dt	Peak Diode Recovery ²	5.5V / ns		
$R_{ heta JC}$	Thermal Resistance Junction – C	0.83°C / W		
$R_{ hetaJA}$	Thermal Resistance Junction – A	48°C / W		
$R_{\theta CS}$	Thermal Resistance Case – Sink	0.21°C / W typ.		
T_J , T_STG	Operating Junction and Storage T	−55 to 150°C		
TL	Lead Temperature (1.6mm from c	300°C		

- 1)
- V_{DD} = 25V , Starting T_J = 25°C , L \geq 1mH , R_G = 25 Ω , Peak I_L = 27.4A I_{SD} \leq 27.4A , di/dt \leq 190A / μS , V_{DD} \leq BV_{DSS} , T_J \leq 150°C , Suggested R_G = 2.35 Ω 2)

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IRFM250 2N7225

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise stated)

	arameter Test Conditions		tions	Min.	Тур.	Max.	Unit
	STATIC ELECTRICAL RATINGS	•	'				
BV _{DSS}	Drain – Source Breakdown Voltage	$V_{GS} = 0$	I _D = 1mA	200			V
ΔBV_{DSS}	Temperature Coefficient of	Reference to 25°C I _D = 1mA			0.28		V/°C
ΔT_{J}	Breakdown Voltage						
R _{DS(on)}	Static Drain - Source On-State	V _{GS} = 10V			0.100		
	Resistance ²	V _{GS} = 10V	I _D = 27.4A			0.105	$ \Omega$
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$	I _D = 250μA	2		4	V
9 _{fs}	Forward Transconductance ²	$V_{DS} \ge 15V$	I _{DS} = 17A	9			S(Ω)
I _{DSS}	Zero Gate Voltage Drain Current	$V_{GS} = 0$	$V_{DS} = 0.8BV_{DSS}$			25	μΑ
			T _J = 125°C			250	
I _{GSS}	Forward Gate – Source Leakage	V _{GS} = 20V				100	
I _{GSS}	Reverse Gate – Source Leakage	$V_{GS} = -20V$	_{GS} = -20V				- nA
	DYNAMIC CHARACTERISTICS	1					
C _{iss}	Input Capacitance	V 0			3500		
C _{oss}	Output Capacitance		$V_{GS} = 0$ $V_{DS} = 25V$				pF
C _{rss}	Reverse Transfer Capacitance	1					
C _{DC}	Drain - Case Capacitance	f = 1MHz		12		1	
Q _q	Total Gate Charge	V _{GS} = 10V		55		115	
Q _{gs}	Gate - Source Charge	$I_D = 27.4A$		8		22	nC
Q _{gd}	Gate - Drain ("Miller") Charge	$V_{DS} = 0.5BV_{DS}$	$V_{DS} = 0.5BV_{DSS}$			60	
t _{d(on)}	Turn- On Delay Time	V 100V	$V_{DD} = 100V$ $I_D = 27.4A$ $Vgs = 10V$ $R_G = 2.35\Omega$			35	- ns
t _r	Rise Time					190	
t _{d(off)}	Turn-Off Delay Time	-				170	
t _f	Fall Time	$H_{G} = 2.35\Omega$				130	
	SOURCE - DRAIN DIODE CHARAC	TERISTICS	l.				
I _S	Continuous Source Current					27.4	_
I _{SM}	Pulse Source Current ¹					110	A
V_{SD}	Diode Forward Voltage ²	$I_S = 27.4A$ $V_{GS} = 0$	T _J = 25°C			1.9	V
t _{rr}	Reverse Recovery Time ²	I _F = 27.4A	T _J = 25°C			950	ns
Q _{rr}	Reverse Recovery Charge ²	d _i / d _t ≤ 100A/μs	s V _{DD} ≤ 50V			9.0	μС
t _{on}	Forward Turn-On Time				Negligible	<u> </u>	
	PACKAGE CHARACTERISTICS						
L _D	Internal Drain Inductance Measured from	ctance Measured from 6mm down drain lead to centre of die			8.7		пЦ
L _S	Internal Source Inductance Measured from	om 6mm down source I		8.7		- nH	

¹⁾ Repetitive Rating – Pulse width limited by Maximum Junction Temperature

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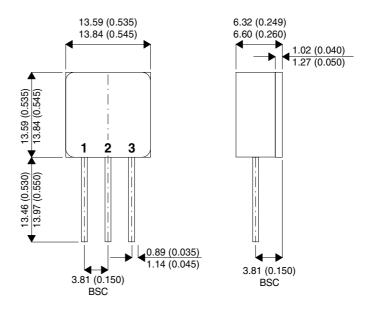
²⁾ Pulse Test: Pulse Width \leq 300 μ s, $\delta \leq$ 2%.



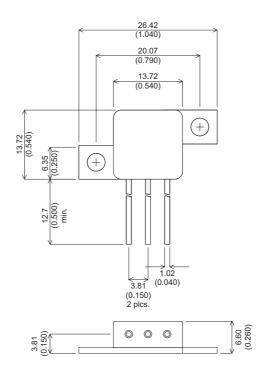


PACKAGE OPTIONS

TABLESS



SIDE TAB



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